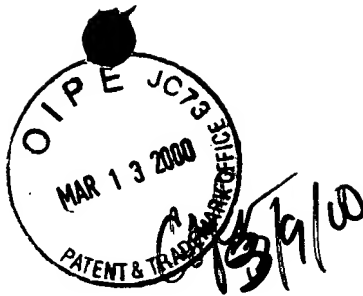


MSLIN98-001



March 6 2000

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

ATTN: GROUP ART UNIT 2822 K. M. PICARDAT

FR: Stephen B. Ackerman Reg. No. 37761  
20 McIntosh Drive  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 09/131,429 ✓	08/10/98 ✓
M. S. Lin ✓	
"Wafer Scale Packaging Scheme"	
Grp. Art Unit : 2822	K. Picardat

TO: 2.01 MAIL ROOM  
DATE: 3/13/00  
TIME: 11:00

#6/A  
Amelt  
J. M. Amelt  
3/20/00

RESPONSE TO PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated December 10, 1999, in the above identified application for patent, please add the new claim shown below and consider the following remarks.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on March 7, 2000.

Name Stephen B. Ackerman

Signature/Date [Signature] 3/9/00